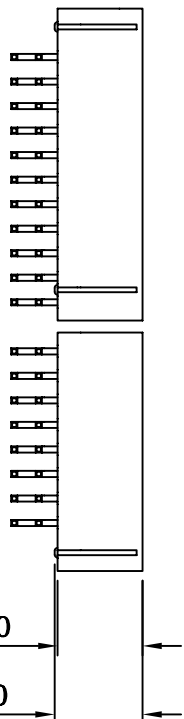
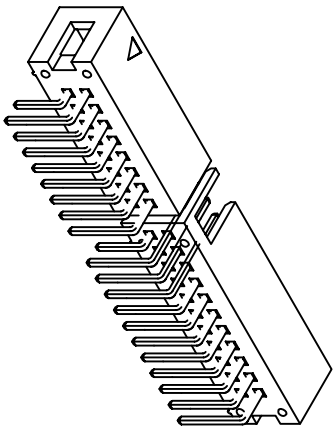


Current Rating: 3 Amps
 Insulator Resistance: 5000 Megoohms min
 Contact Resistance: 20m ohms max.
 Dielectric Withstanding: 1000 V AC
 Operating Temperature: -40° ~ +105° C
 Contact Material: Copper Alloy
 Insulator Material: Polyester, UL 94V-0
 Standard: PBT

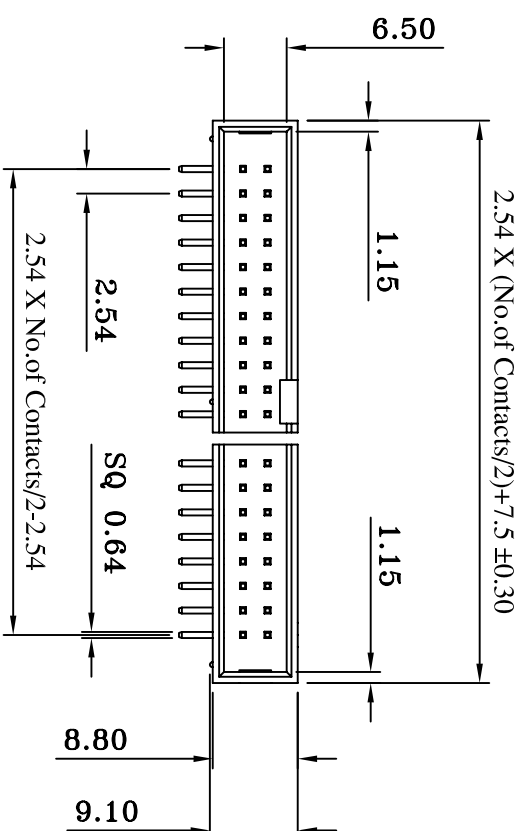
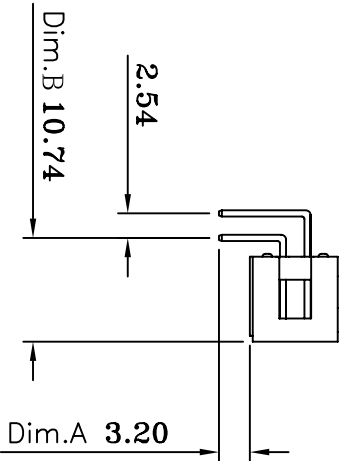
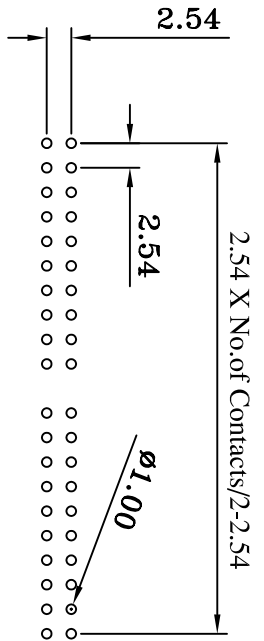
Finish: Gold Plated or Duplex Plated
 Standard: Gold Flash all over

Note:
 Duplex Plating: Gold Plated on contact area,
 Tin on solder area

Insulator Material: Polyester, UL 94V-0
 Standard: Nylon-6T
 Max Processing Temp: 230° C for 60 seconds
 Max Processing Temp: 260° C for 10 seconds



Recommended P.C. Board Hole Layout



BH11 X X - XX R0 BK X 000 C

1 2 3 4 5 6 7 8

(RoHS Compliant)

- Insulator Material:
 - A= P.B.T
 - N= Nylon-6T
- Contact Plated:
 - T=Matte Tin over Nickel
 - W=Matte Tin over Nickel 150u"
 - Y=Bright Tin over Nickel
 - C=Gold Flash
 - F=Gold Flash,Matte Tin 100u"
 - A=Gold 3u"
 - B=Gold 3u",Matte Tin 100u"
 - D=Gold 5u"
- Circuit: 06~50 pin
- Tail Style:
 - R0= Right Angle
 - Color: BK=Black
- Contact Plated:
 - E=Gold 5u",Matte Tin 100u"
 - G=Gold 10u"
 - J=Gold 10u",Matte Tin 100u"
 - L=Gold 15u"
 - M=Gold 15u",Matte Tin 100u"
 - U=Gold 30u"
 - V=Gold 30u",Matte Tin 100u"
- Special Options
 - C=Tray
- Packing: C=Tray

©: Circuits: 06-64 pin-2008/04/08-C1		CONN TOP COMPONENT INC.		PART NO		BH11XX-XXR0BKX000C		.X		.XX		.XXX	
①: BH11XX-XXR0BKX000-2007/03/22-C		COMPONENT INC.		DRAWING NO		BH-00018		±0.3		±0.20		±0.100	
BOM 1: BH11X-XXBKH0		DRAWN BY		LIN		2008/11/14		C2		SCALE: 1:1		BH	
BOM 2: QT-0.64X16.00BN		APPROVAL BY										UNIT: m.m	
BOM 3: QT-0.64X21.00BN													
TEL: (02)86481727 FAX: (02)86482427													

4.50 (6P=2.50mm)